Approved Minutes IEEE P802.3db 100 Gb/s, 200 Gb/s, and 400 Gb/s Short Reach Fiber Task Force Interim Meeting

Webex Meeting May 27, 2021 Prepared by Mabud Choudhury

Group Name: IEEE P802.3db 100 Gb/s, 200 Gb/s, and 400 Gb/s Short Reach Fiber Task Force
Date/Location: Thursday, May 27, 2021. Webex meeting.
Chair: Robert Lingle, Jr (OFS)
Editors: Ramana Murty (Broadcom), Earl Parsons (CommScope)
Recording Secretary: Mabud Choudhury (OFS)
Meeting Participants: Attendance is listed in Appendix A (47 attendees – based on Webex participants list)

Call to order:

IEEE P802.3db 100 Gb/s, 200 Gb/s, and 400 Gb/s Short Reach Fiber Task Force (TF) Interim Webex meeting was convened at 12:00 Noon Eastern Daylight Time (EDT/ UTC -4), Thursday, May 27, 2021, by Robert Lingle, Jr., P802.3db TF Chair.

Webex Meeting Procedures:

He instructed attendees to either add their affiliations to their names in the Webex participants list, or else list their name with affiliation in the chat window – a meeting requirement. [These two instructions were repeated multiple times throughout the meeting via Chat].

Chair's Presentation:

Title: "Agenda and General Information" Presenter: Robert Lingle, Jr. (OFS) agenda 3db 01 052721.pdf

Mr. Lingle then proceeded with reviewing the **Agenda**, Slide 3 of <u>agenda 3db 01 052721.pdf</u> and asked if there were any modifications, additions or deletions? There were none.

.3db Motion #1:

Move to approve the Agenda for Interim TF Teleconference, Slide 3 of agenda 3db 01 052721.pdf

- M: John Abbott
- S: Lance Thompson
- (Procedural > 50%)
- Motion approved by unanimous consent.

Agenda approved at 12:03 PM

Approved Agenda:

- Welcome
- Approve Agenda
- Attendance
- Goals for this meeting

- Reflector and Web
- Ground Rules
- IEEE
 - Structure, Bylaws and Rules
 - Call for Patents. IEEE Patent Policy reminder: <u>http://www.ieee802.org/3/patent.html</u>
 - IEEE Copyright reminder: <u>https://standards.ieee.org/ipr/index.html</u>
 - IEEE Participant reminder: <u>http://www.ieee802.org/devdocs.shtml</u>
 - IEEE Standards Process
- PAR & Objectives
- Updated D1.0 Editors' Report Earl Parsons (CommScope), Ramana Murty (Broadcom)
- Contributions:
 - "Support for a comment proposing better emulation of fiber dispersion for multimode TDECQ" - Greg D. Le Cheminant (Keysight), Marlin Viss (Keysight)
 "List of TBDs in Clause 167", Bamana Murty (Breadsom), Earl Barsons (CommScon)
 - "List of TBDs in Clause 167" Ramana Murty (Broadcom), Earl Parsons (CommScope)
- Straw Polls & Motions may occur throughout the meeting
- Future Meetings

Attendance: Chair asked attendees to use <u>http://imat.ieee.org/</u> to record attendance, provided Session Code, and reviewed the IMAT steps to log attendance for this TF meeting. Unfortunately, IMAT was down for maintenance and could not be accessed during first 15 to 20 minutes of the meeting. Additionally, IMAT attendance could be recorded for only one meeting of the three parallel TF/SG meetings at the same time during WG interim meeting weeks. Therefore, Chair indicated that official attendance for this meeting would be based on Webex Participant List and with Chat to Everyone with Name and Affiliation for those whose Name and Affiliation was not displayed on Webex Participant List.

Task Force Decorum: Chair asked for attendees to stay on mute when not speaking. Chair asked if anyone from the **Press** was present – no one indicated that they were from the Press.

Mr. Lingle provided Goals for the meeting:

- Complete comment resolution against D1.0
- Approve motion to authorize D1.1
- Review list of Clause 167 TBDs and identify owners and dates for contributions (along with consensus building) to determine/agree to specified values for all TBDs with D1.1 and D1.2 (last TF review draft)

Reflector and Web: Chair showed the links to the IEEE 802.3db 100 Gb/s, 200 Gb/s, and 400 Gb/s Short Reach Fiber Task Force page, and the email reflector.

TF Private Area: Chair provided Username and Password for TF private area. All draft standards will be in private area.

Chair reviewed: **Ground Rules:** slide 11 of <u>agenda_3db_01_052721.pdf</u> **IEEE Structure:** slide 12 of <u>agenda_3db_01_052721.pdf</u> **Important Bylaws and Rules:** slide 13 of <u>agenda_3db_01_052721.pdf</u> TF Secretary had shared the IEEE SA Patent, Copyright and Participation Policies prior to the meeting and had asked participants to be familiar these policies. Mr. Lingle asked if any participants had questions, and that there were no questions.

IEEE SA Patent Policy: Mr. Lingle provided overview of slides 14-18 of <u>agenda 3db 01 052721.pdf</u>. Chair made "**Call for Potentially Essential Patents**" at 12:11 PM. No response from TF participants.

IEEE SA Copyright Policy: Mr. Lingle showed slides 19-21 of <u>agenda 3db 01 052721.pdf</u> entitled "IEEE SA Copyright Policy" overview

IEEE SA Participation Policy: Mr. Lingle showed the participation policy overview slides 22-24 of <u>agenda_3db_01_052721.pdf</u>.

Mr. Lingle then reviewed the Overview of IEEE 802.3 Standards Process – completed Study Group Phase, and now in Task Force Comment Phase (slide 26 of <u>agenda 3db 01 052721.pdf</u>).

Chair showed links for Approved Project Documents: PAR, CSD and Objectives slide 30 of <u>agenda_3db_01_052721.pdf</u>). Mr. Lingle then showed the TF Objectives and Timeline, indicating that TF is now back on timeline schedule.

Editors' Report:

Title: "802.3db Editors' Report and Comment Agenda"Presenters: Editors Ramana Murty (Broadcom Inc.) and Earl Parsons (CommScope)editors report D1p0 3db 01 052721.pdf

- Editorial team:
 - Earl Parsons, CommScope, Co-editor <u>earl.parsons@commscope.com</u>
 - o Ramana Murty, Broadcom, Co-editor <u>ramana.murty@broadcom.com</u>
- Status:
 - Draft 1.0 was posted to P802.3db private area April 21st
 - Included:
 - Changes discussed during comment resolution against D0.2 on Apr 15 •
 - Editorial changes to Clauses 1, 30, 78, 91, 116 and 167 as well as Introduction and Front matter as described on slide 11 in <u>https://www.ieee802.org/3/db/public/April 15</u> 2021/editors report comments D0p2 3db 01 041521.pdf
 - Clause 45
 - o D1.0 was open for comments through Wednesday, May 5th
 - Comments were received from five individuals
 - 31 total comments
 - o Comments and proposed responses were posted May 11th
 - Thank you to everyone who commented!
- Comment resolution against D1.0 resumed from last TF meeting.
- Technical discussion followed. Topics included: MDI/APC MPO-12, TDECQ, emulation of fiber dispersion, test methodology including following contribution:

Contribution #1:

Title: "Support for a comment proposing better emulation of fiber dispersion for multimode TDECQ" **Presenter:** Greg D. Le Cheminant (Keysight Technologies) le_cheminant_3db_01_052721.pdf

• Presentation provides:

- Proposal for better emulation of the fiber response and potentially achieve better accuracy in assessing the transmitter dispersion penalty without incurring extra measurement time or cost. This can also simplify the testing of other transmitter parameters.
- The end goal is to determine a practical test method that predicts the transmitter eye closure penalty.
- In support of comment ID 30. Presentation adds proposed "Prior to TDECQ analysis the waveform is passed through a function that emulates the response of the maximum allowed fiber span. This function is described as a fourth order Bessel response with a -3dB bandwidth of 18 GHz" (the last part adds to comment ID 30)
- The TF should determine what best represents the effect of the fiber, with the 18 GHz value as proposed best estimate at this time.
- Presenter indicated that what we do today is not wrong, but measurement technology is evolving, and he is thinking about potential improvements.
- Technical discussion followed.
- Presenter welcomed feedback from the group and answered clarifying questions.

Comment resolution concluded with all comments against D1.0 closed, along with proposed responses for "bucket" comments.

.3db Motion #2:

- Move to adopt proposed responses to remaining comments, noted as "bucket" on slide 7 of <u>editors_report_D1p0_3db_01_052721.pdf</u>, and generate Draft 1.1 from Draft 1.0 and closed comments.
- M: Earl Parsons
- S: Ramana Murty
- Y: N: A:
- Technical (>/=75% of 802.3 voters)
- Motion is approved by unanimous consent.

Contribution #2:

Title: "List of TBDs in Clause 167"

Presenter: Ramana Murty (Broadcom)

clause 167 tbd list 3db 01a 052721.pdf

Version 01a update adds owners and dates for contributions to provide values for Clause 167 TBDs – as discussed and agreed to during the meeting.

• Based on TF discussion, the following was agreed to (dates subject to change):

TBD	Owner	Date
Center wavelength	Dave Lewis	24-Jun
TDECQ	Piers Dawe	July
# taps on the reference equalizer	Piers Dawe	July
Stressed receiver sensitivity (OMA outer), each lane (max)	Yi Tang	10-Jun
Over/undershoot	Ramana Murty	July
TDECQ calculation method	Ali, Greg	July
Constraints on tap coefficients	Piers Dawe	July?

Future TF meetings:

- See: <u>http://ieee802.org/3/calendar.html</u> and <u>http://ieee802.org/3/interims/index.html</u>
- P802.3db TF Ad Hoc Teleconferences are currently scheduled:
 - Biweekly on Thursdays at 12 Noon to 2 pm Eastern US (EST/UTC -5): http://www.ieee802.org/3/db/public/adhoc/index.html
 - Next Ad Hoc meeting: Thursday, June 10, 2021, 12 Noon to 2 pm Eastern Daylight US (EDT/UTC -4)
 - Ad Hoc meetings will be converted to TF interims when TF business requires
- P802.3db TF Interim Teleconferences:
 - On TF interim teleconferences, only 802.3 voters may vote on TF motions

Future WG meetings:

Meeting	Location	Dates
IEEE 802 July 2021 plenary	Virtual	12-15 & 19-22 July 2021
IEEE 802.3 September 2021 interim	Virtual	TBD September 2021
IEEE 802 November 2021 plenary	Vancouver, BC, Canada	15-18 November 2021
IEEE 802.3 January 2022 interim	TBD	10-14 & 17-21 January 2022
IEEE 802 March 2022 plenary	Orlando, FL, USA	14-17 March 2022
IEEE 802.3 May 2022 interim	TBD	16-20 & 23-27 May 2022
IEEE 802 July 2022 plenary	Montreal, Quebec, Canada	11-14 July 2022
IEEE 802.3 September 2022 interim	TBD	5-9 & 12-16 September 2022
IEEE 802 November 2022 plenary	Bangkok, Thailand	14-17 November 2022
l la comina no octina dotoilo otubit	n://iooo802.org/2/interime/index	e la tran l

Upcoming meeting details at: <u>http://ieee802.org/3/interims/index.html</u>

2:35 PM: Mr. Lingle had to leave before end of meeting and asked Mr. Choudhury to chair meeting to finish meeting.

.3db Motion #3:

Move to Adjourn TF Telephonic Interim Meeting

- M: James Young
- S: Mike Dudek
- (Procedural > 50%)
- Motion passes by unanimous consent

The Task Force Interim meeting was adjourned at 2:51 PM EDT/ UTC -4, Tuesday, May 27, 2021.

Next Meeting:

Scheduled P802.3db TF Ad Hoc Webex meeting for Thursday, June 10, 2021 at 12:00 Noon – 2:00 PM EDT/UTC -4 (subsequently canceled due to postponed contribution).

2 Bolig, Matthew Inphi Corporation Inphi Corporation 3 Bottoni, Fabio Cisco Systems, Inc. Cisco Systems, Inc. 4 Chang, Yongmao Inphi Corporation Source Photonics 5 Chen, Chan Applied Optoelectronics, Inc. Applied Optoelectronic 6 Choudhury, Mabud OFS OFS 7 Dawe, Piers J G NVIDIA Nvidia 8 Dudek, Michael Marvell Marvell 9 Ferretti, Vincent Corning Incorporated Corning Incorporated 10 He, Xiang Huawei Technologies Co., Ltd Huawei Technologies Co. 11 Healey, Adam Broadcom Inc. Broadcom Inc. Broadcom Inc. 12 Hukangmin Innogrit Innogrit Innogrit 14 Jackson, Kenneth Sumitomo Electric Device Innovations, USA Sumitomo Electric Indu 15 Kamino, John OFS Sematech Ltd Sematech Ltd 16 Kimber, Eric Semtech Ltd Macom Macom 17		Name	Employer	Affiliation
3 Bottoni, Fabio Cisco Systems, Inc. Cisco Systems, Inc. 4 Chang, Yongmao Inphi Corporation Source Photonics 5 Chen, Chan Applied Optoelectronics, Inc. Applied Optoelectronic 6 Choudhury, Mabud OFS OFS 7 Dawe, Piers J G NVIDIA Nvidia 8 Dudek, Michael Marvell Marvell 9 Ferretti, Vincent Corning Incorporated Corning Incorporated 10 He, Xiang Huawei Technologies Co., Ltd Huawei Technologies Co. 11 Healey, Adam Broadcom Inc. Broadcom Inc. 12 Hidaka, Yasuo Credo Semiconductor Credo Semiconductor 13 Hu, Kangmin Innogrit Innogrit Innogrit 14 Jackson, Kenneth Sumitomo Electric Device Innovations, USA Sumitomo Electric Indu 17 Klempa, Michael University of New Hampshire InterOperability Laboratory (UNH-IOL) Amphenol Corporation 18 Latchman, Ryan Macom Macom Macom 19 <td>1</td> <td>Akbaba, Enis</td> <td>Maxim Integrated Products</td> <td>Maxim Integrated Produ</td>	1	Akbaba, Enis	Maxim Integrated Products	Maxim Integrated Produ
4 Chang, Yongmao Inphi Corporation Source Photonics 5 Chen, Chan Applied Optoelectronics, Inc. Applied Optoelectronic 6 Choudhury, Mabud OFS OFS 7 Dawe, Piers J G NVIDIA Nvidia 8 Dudek, Michael Marvell Marvell 9 Ferretti, Vincent Corning Incorporated Corning Incorporated 10 He, Xiang Huawei Technologies Co., Ltd Huawei Technologies Co. 11 Healey, Adam Broadcom Inc. Broadcom Inc. 12 Hidaka, Yasuo Credo Semiconductor Credo Semiconductor 13 Hu, Kangmin Innogrit Innogrit 14 Jackson, Kenneth Sumitomo Electric Device Innovations, USA Sumitomo Electric Indu 15 Kamino, John OFS OFS Semetch Ltd 16 Kimber, Eric Semtech Ltd Macom Macom 19 Le Cheminant, Greg Keysight Technologies Co., Ltd Huawei Technologies Co., Ltd Huawei Technologies Co., Ltd 21	2	Bolig, Matthew	Inphi Corporation	Inphi Corporation
5 Chen, Chan Applied Optoelectronics, Inc. Applied Optoelectronic 6 Choudhury, Mabud OFS OFS 7 Dawe, Piers J G NVIDIA Nvidia 8 Dudek, Michael Marvell Marvell 9 Ferretti, Vincent Corning Incorporated Corning Incorporated 10 He, Xiang Huawei Technologies Co., Ltd Huawei Technologies Co. 11 Healey, Adam Broadcom Inc. Broadcom Inc. 12 Hidaka, Yasuo Credo Semiconductor Credo Semiconductor 13 Hu, Kangmin Innogrit Innogrit 14 Jackson, Kenneth Sumitomo Electric Device Innovations, USA Sumitomo Electric Indu 15 Kamino, John OFS OFS 16 Kimber, Eric Semtech Ltd Semtech Ltd 17 Klempa, Michael University of New Hampshire InterOperability Laboratory (UNH-IOL) Amphenol Corporation 18 Latchman, Ryan Macom Keysight Technologies Keysight Technologies Co., Ltd 11 Lewis, David Lumentum Inc. Lumentum Inc. Cisco Systems, Inc. 12 Ling, Robert OFS OFS Start Semters, Inc. 24 Ling, Robert OFS <td< td=""><td>3</td><td>Bottoni, Fabio</td><td>Cisco Systems, Inc.</td><td>Cisco Systems, Inc.</td></td<>	3	Bottoni, Fabio	Cisco Systems, Inc.	Cisco Systems, Inc.
6 Choudhury, Mabud OFS 7 Dawe, Piers J G NVIDIA Nvidia 8 Dudek, Michael Marvell Corning Incorporated 9 Ferretti, Vincent Corning Incorporated Corning Incorporated 10 He, Xiang Huawei Technologies Co., Ltd Huawei Technologies Co. 11 Healey, Adam Broadcom Inc. Broadcom Inc. 12 Hidaka, Yasuo Credo Semiconductor Credo Semiconductor 13 Hu, Kangmin Innogrit Innogrit 14 Jackson, Kenneth Sumitomo Electric Device Innovations, USA Sumitomo Electric Indu 15 Kamino, John OFS Semtech Ltd Semtech Ltd 17 Klempa, Michael University of New Hampshire InterOperability Laboratory (UNH-IOL) Amphenol Corporation 18 Latchman, Ryan Macom Macom Macom 10 Le Cheminant, Greg Keysight Technologies Co., Ltd Lumentum Inc. 21 Ledentsov, Nikolay VI Systems GmbH VI Systems GmbH 22 Lidentsov, Nikolay Huawei Technologies Co., Ltd Lumentum Inc.	4	Chang, Yongmao	Inphi Corporation	Source Photonics
7Dawe, Piers J GNVIDIANvidia8Dudek, MichaelMarvellMarvellMarvell9Ferretti, VincentCorning IncorporatedCorning Incorporated10He, XiangHuawei Technologies Co., LtdHuawei Technologies Co11Healey, AdamBroadcom Inc.Broadcom Inc.12Hidaka, YasuoCredo SemiconductorCredo Semiconductor13Hu, KangminInnogritInnogrit14Jackson, KennethSumitomo Electric Device Innovations, USASumitomo Electric Indu15Kamino, JohnOFSOFS16Kimber, EricSemtech LtdSemtech Ltd17Klempa, MichaelUniversity of New Hampshire InterOperability Laboratory (UNH-IOL)Amphenol Corporation18Latchman, RyanMaccomMaccomMaccom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies Co., Ltd20Ledentsov, NikolayVI Systems GmbHVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Lumentum Inc.22Lin, JaneCisco Systems, Inc.Cisco Systems, Inc.23Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC <tr< td=""><td>5</td><td>Chen, Chan</td><td>Applied Optoelectronics, Inc.</td><td>Applied Optoelectronics</td></tr<>	5	Chen, Chan	Applied Optoelectronics, Inc.	Applied Optoelectronics
8 Dudek, Michael Marvell Marvell 9 Ferretti, Vincent Corning Incorporated Corning Incorporated 10 He, Xiang Huawei Technologies Co., Ltd Huawei Technologies Co. 11 Healey, Adam Broadcom Inc. Broadcom Inc. 12 Hidaka, Yasuo Credo Semiconductor Credo Semiconductor 13 Hu, Kangmin Innogrit Innogrit 14 Jackson, Kenneth Sumitomo Electric Device Innovations, USA Sumitomo Electric Indu 15 Kamino, John OFS OFS 16 Kimber, Eric Semtech Ltd Semtech Ltd 17 Klempa, Michael University of New Hampshire InterOperability Laboratory (UNH-IOL) Amphenol Corporation 18 Latchman, Ryan Macom Macom 19 Le Cheminant, Greg Keysight Technologies Keysight Technologies 20 Ledentsov, Nikolay VI Systems GmbH VI Systems GmbH 21 Lewis, David Lumentum Inc. Lumentum Inc. 22 Lim, Jane Cisco Systems, Inc. Gisco Systems, Inc. 23 Lin, Youxi Huawei Technologies Co., Ltd Huawei Technologies Co., Ltd. 24 Ingle, Robert OFS OFS	6	Choudhury, Mabud	OFS	OFS
9Ferretti, VincentCorning IncorporatedCorning Incorporated10He, XiangHuawei Technologies Co., LtdHuawei Technologies Co.11Healey, AdamBroadcom Inc.Broadcom Inc.12Hidaka, YasuoCredo SemiconductorCredo Semiconductor13Hu, KangminInnogritInnogrit14Jackson, KennethSumitomo Electric Device Innovations, USASumitomo Electric Indu15Kamino, JohnOFSOFS16Kimber, EricSemtech LtdSemtech Ltd17Klempa, MichaelUniversity of New Hampshire InterOperability Laboratory (UNH-IOL)Amphenol Corporation18Latchman, RyanMacomMacom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Lumentum Inc.22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Marques, FlavioCisco Systems, Inc.Samtec-Macom30Nering,	7	Dawe, Piers J G	NVIDIA	Nvidia
10He, XiangHuawei Technologies Co., LtdHuawei Technologies Co.11Healey, AdamBroadcom Inc.Broadcom Inc.12Hidaka, YasuoCredo SemiconductorCredo Semiconductor13Hu, KangminInnogritInnogrit14Jackson, KennethSumitomo Electric Device Innovations, USASumitomo Electric Indu15Kamino, JohnOFSOFS16Kimber, EricSemtech LtdSemtech Ltd17Klempa, MichaelUniversity of New Hampshire InterOperability Laboratory (UNH-IOL)Amphenol Corporation18Latchman, RyanMacomMacom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Cisco Systems, Inc.22Lin, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Marques, FlavioCisco Systems, Inc.Samtec-Macom30Nering, RaymondCisco Systems, Inc.Samtec-Macom31Palkert, Tho	8	Dudek, Michael	Marvell	Marvell
11Healey, AdamBroadcom Inc.Broadcom Inc.12Hidaka, YasuoCredo SemiconductorCredo Semiconductor13Hu, KangminInnogritInnogrit14Jackson, KennethSumitomo Electric Device Innovations, USASumitomo Electric Indu15Kamino, JohnOFSOFS16Kimber, EricSemtech LtdSemtech Ltd17Klempa, MichaelUniversity of New Hampshire InterOperability Laboratory (UNH-IOL)Amphenol Corporation18Latchman, RyanMacomMacom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHUliversity of New Hampshire InterOperability Laboratory (UNH-IOL)Amphenol Corporation18Latchman, RyanMacomMacomMacom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHUliverstim Inc.21Lewis, DavidLumentum Inc.Lumentum Inc.22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, L	9	Ferretti, Vincent	Corning Incorporated	Corning Incorporated
12Hidaka, YasuoCredo SemiconductorCredo Semiconductor13Hu, KangminInnogritInnogritInnogrit14Jackson, KennethSumitomo Electric Device Innovations, USASumitomo Electric Indu15Kamino, JohnOFSOFS16Kimber, EricSemtech LtdSemtech Ltd17Klempa, MichaelUniversity of New Hampshire InterOperability Laboratory (UNH-IOL)Amphenol Corporation18Latchman, RyanMacomMacom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Lumentum Inc.22Lin, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICBroadcom Corporation28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Samtec-Macom31Palkert, ThomasMacom, Anbsp;SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickP	10	He, Xiang	Huawei Technologies Co., Ltd	Huawei Technologies Co
13Hu, KangminInnogritInnogrit14Jackson, KennethSumitomo Electric Device Innovations, USASumitomo Electric Indu15Kamino, JohnOFSOFS16Kimber, EricSemtech LtdSemtech Ltd17Klempa, MichaelUniversity of New Hampshire InterOperability Laboratory (UNH-IOL)Amphenol Corporation18Latchman, RyanMacomMacom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Lumentum Inc.22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICBroadcom Corporation29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Cisco Systems, Inc.31Palkert, ThomasMacom, Anbsp;SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	11	Healey, Adam	Broadcom Inc.	Broadcom Inc.
14Jackson, KennethSumitomo Electric Device Innovations, USASumitomo Electric Indu15Kamino, JohnOFSOFS16Kimber, EricSemtech LtdSemtech Ltd17Klempa, MichaelUniversity of New Hampshire InterOperability Laboratory (UNH-IOL)Amphenol Corporation18Latchman, RyanMacomMacom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Lumentum Inc.22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lingle, RobertOFSOFS24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Samtec-Macom31Palkert, ThomasMacom, Anos, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.Samtec-Macom33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	12	Hidaka, Yasuo	Credo Semiconductor	Credo Semiconductor
15Kamino, JohnOFSOFS16Kimber, EricSemtech LtdSemtech LtdSemtech Ltd17Klempa, MichaelUniversity of New Hampshire InterOperability Laboratory (UNH-IOL)Amphenol Corporation18Latchman, RyanMacomMacom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Lumentum Inc.22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Samtec-Macom31Palkert, ThomasMacom, Anbsp;SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	13	Hu, Kangmin	Innogrit	Innogrit
16Kimber, EricSemtech LtdSemtech Ltd17Klempa, MichaelUniversity of New Hampshire InterOperability Laboratory (UNH-IOL)Amphenol Corporation18Latchman, RyanMacomMacom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Lumentum Inc.22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Samtec-Macom31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	14	Jackson, Kenneth	Sumitomo Electric Device Innovations, USA	Sumitomo Electric Indus
17Klempa, MichaelUniversity of New Hampshire InterOperability Laboratory (UNH-IOL)Amphenol Corporation18Latchman, RyanMacomMacom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Lumentum Inc.22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICUS Conec, Ltd.28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Samtec-Macom30Nering, RaymondCisco Systems, Inc.Samtec-Macom31Palkert, ThomasMacom, SamtecSamtec-Macom32Piropinella, RickPanduit Corp.Panduit Corp.	15	Kamino, John	OFS	OFS
18Latchman, RyanMacomMacom19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Lumentum Inc.22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Cisco Systems, Inc.31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	16	Kimber, Eric	Semtech Ltd	Semtech Ltd
19Le Cheminant, GregKeysight TechnologiesKeysight Technologies20Ledentsov, NikolayVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Lumentum Inc.22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Samtec-Macom31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CormScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	17	Klempa, Michael	University of New Hampshire InterOperability Laboratory (UNH-IOL)	Amphenol Corporation
20Ledentsov, NikolayVI Systems GmbHVI Systems GmbH21Lewis, DavidLumentum Inc.Lumentum Inc.22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Samtec-Macom31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.34Pinpinella, RickPanduit Corp.Panduit Corp.	18	Latchman, Ryan	Macom	Macom
21Lewis, DavidLumentum Inc.Lumentum Inc.22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Cisco Systems, Inc.31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.34Pimpinella, RickPanduit Corp.Panduit Corp.	19	Le Cheminant, Greg	Keysight Technologies	Keysight Technologies
22Lim, JaneCisco Systems, Inc.Cisco Systems, Inc.23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Cisco Systems, Inc.31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	20	Ledentsov, Nikolay	VI Systems GmbH	VI Systems GmbH
23Lin, YouxiHuawei Technologies Co., LtdHuawei Technologies Co.24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Samtec-Macom31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	21	Lewis, David	Lumentum Inc.	Lumentum Inc.
24Lingle, RobertOFSOFS25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Sol27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Cisco Systems, Inc.31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	22	Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.
25Maki, JefferyJuniper Networks, Inc.Juniper Networks, Inc.26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Solutions27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Cisco Systems, Inc.31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	23	Lin, Youxi	Huawei Technologies Co., Ltd	Huawei Technologies Co
26Malicoat, DavidMalicoat Networking SolutionsMalicoat Networking Solutions27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Cisco Systems, Inc.31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	24	Lingle, Robert	OFS	OFS
27Marques, FlavioFURUKAWA ELECTRICFURUKAWA ELECTRIC28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Cisco Systems, Inc.31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	25	Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.
28Mitcheltree, TomUS Conec, Ltd.US Conec, Ltd.29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Cisco Systems, Inc.31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	26	Malicoat, David	Malicoat Networking Solutions	Malicoat Networking So
29Murty, RamanaBroadcom Inc.Broadcom Corporation30Nering, RaymondCisco Systems, Inc.Cisco Systems, Inc.31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	27	Marques, Flavio	FURUKAWA ELECTRIC	FURUKAWA ELECTRIC
30Nering, RaymondCisco Systems, Inc.Cisco Systems, Inc.31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	28	Mitcheltree, Tom	US Conec, Ltd.	US Conec, Ltd.
31Palkert, ThomasMacom, SamtecSamtec-Macom32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	29	Murty, Ramana	Broadcom Inc.	Broadcom Corporation
32Parsons, EarlCommScope, Inc.CommScope, Inc.33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	30	Nering, Raymond	Cisco Systems, Inc.	Cisco Systems, Inc.
33Piehler, DavidDell TechnologiesDell34Pimpinella, RickPanduit Corp.Panduit Corp.	31	Palkert, Thomas	Macom, Samtec	Samtec-Macom
34 Pimpinella, Rick Panduit Corp. Panduit Corp.	32	Parsons, Earl	CommScope, Inc.	CommScope, Inc.
	33	Piehler, David	Dell Technologies	Dell
35 Quan, Yu Huawei Technologies Co., Ltd Huawei Technologies Co.	34	Pimpinella, Rick	Panduit Corp.	Panduit Corp.
	35	Quan, Yu	Huawei Technologies Co., Ltd	Huawei Technologies Co

36	Son, Yung Sung	Optomind Inc	Optomind Inc
37	Sun, Yi	OFS	OFS
38	Tang, Yi	Cisco Systems, Inc.	Cisco Systems, Inc.
39	Thompson, lance	II-VI	Finisar Corporation
40	Ulrichs, Ed	Intel	Intel
41	Young, James	CommScope, Inc.	CommScope
42	Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.

Appendix A: Attendance List IEEE P802.3db Task Force WebEx Interim Meeting 47 individuals attended on Tuesday, 27 May 2021, 12:00 Noon – 2:51 PM EDT/UTC -4

	Last Name	First Name	Employer	Affiliation
1	Abbott	John	Corning Incorporated	Corning Incorporated
2	Bolig	Matt	Marvell	Marvell
3	Bordogna	Mark	Intel	Intel
	Bruckman	Leon	Huawei	Huawei
5	Castro	Jose	Panduit	Panduit
6	Chang	Frank	Source Photonics	Source Photonics
7	Chen	Chan Chih (David)	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc.
8	Choudhury	Mabud	OFS	OFS
9	Dawe	Piers	Nvidia	Nvidia
10	Didde	Stephen	Keysight	Keysight
11	Dube	Кае	UNH-IOL	UNH-IOL
12	Ghiasi	Ali	Ghiasi Quantum	Ghiasi Quantum
13	Не	Xiang	Huawei	Huawei
14	Hidaka	Yasuo	Credo	Credo
15	Jackson	Kenneth	Sumitomo	Sumitomo
	Jones	Peter	Cisco	Cisco
17	Kamino	John	OFS	OFS
18	Kimber	Mark	Semtech	Semtech
19	Latchman	Ryan	Macom	Macom
20	Le Cheminant	Greg	Keysight Technologies	Keysight Technologies
21	Lewis	David	Lumentum	Lumentum
22	Lingle	Robert	OFS	OFS
	Lyubomirsky	Ilya	Marvell	Marvell
24	Maki	Jeffery	Juniper Networks	Juniper Networks
25	Malicoat	David	Malicoat Networking Solutions	Independent; SENKO Advanced Components
26	Marques	Flavio	Furukawa Electric	Furukawa Electric
27	McMillan	Larry	Western Digital	Western Digital
28	Murty	Ramana	Broadcom	Broadcom
29	Nowell	Mark	Cisco	Cisco
30	Palkert	Tom	Macom, Samtec	Macom, Samtec
31	Parsons	Earl	CommScope	CommScope
32	Pimpinella	Rick	Panduit Corp.	Panduit Labs, Panduit Corp.
33	Reddy	Upen	Cisco	Cisco
34	Shubochkin	Roman	OFS	OFS
35	Son	Yung	Optomind	Optomind
36	Sun	Phil	Credo	Credo
37	Sun	Yi	OFS	OFS
38	Takahashi	Tadashi	Nitto Denko Corp	Nitto Denko Corp
39	Takayama	Kazuya	Nitto Denko	Nitto Denko
40	Tang	Yi	Cisco	Cisco
41	Thompson	Lance	II-VI	II-VI
42	Tooyserkani	Pirooz	Cisco	Cisco
43	Tsujita	Yuichi	Nitto Inc	Nitto Inc
44	Ulrichs	Ed	Intel	Intel
45	Young	James	CommScope	CommScope
46	Youxi	Lin	Huawei	Huawei
47	Yu	Quan	Huawei	Huawei